

KPBA-2006SURKVBDC-5MAV

2.0 mm x 0.6 mm Right Angle SMD Chip LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- · Side Looking Dual Color Chip LED, 0.6 mm thickness
- Low power consumption
- Wide viewing angle
- · Ideal for backlight and indicator
- · Tinned pads for improved solderability
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- · RoHS compliant

APPLICATIONS

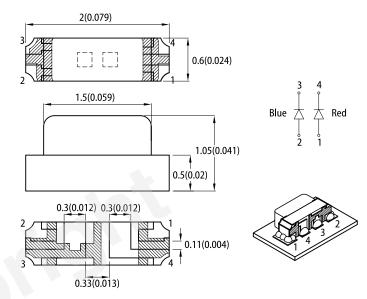
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

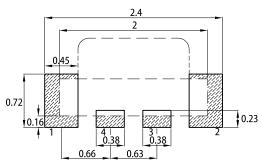
Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN



- All dimensions are in millimeters (inches).
 Package dimensions tolerance is ±0.1(0.004") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- 5. The specifications, characteristics and tearminal data described in the datastiest are subject to change without prior notice.
 4. The device has a single mounting surface. The device must be mounted according to the specifications.
 5. For right angle SMD LEDs, the solder stencil should be at least 5mil in thickness, to prevent poor solder wetting due to insufficient solder paste.

SELECTION GUIDE

Part Number	t Number Emitting Color Long Type		Iv (mcd) @ 5mA [2]		Viewing Angle [1]	
r art Number	(Material)	Lens Type	Min.	Тур.	201/2	
KPBA-2006SURKVBDC-5MAV	■ Hyper Red (AlGaInP)	Water Clear	15	60		
			*6	*20	140°	
	■ Blue (InGaN)		20	50	140	
			*20	*50		

toles.

6/1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity / luminous flux: +/-15%.

Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Тур.	Max.	Unit
Wavelength at Peak Emission $I_F = 5mA$	λ_{peak}	Hyper Red Blue	645 465	-	nm
Dominant Wavelength I _F = 5mA	λ _{dom} ^[1]	Hyper Red Blue	630 470	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	Δλ	Hyper Red Blue	28 22	-	nm
Forward Voltage I _F = 5mA	V _F ^[2]	Hyper Red Blue	1.8 2.8	2.3 3.2	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Blue	-	10 50	μА
Temperature Coefficient of λ_{peak} $I_F = 5mA$, -10°C $\leq T \leq 85$ °C	$TC_{\lambda peak}$	Hyper Red Blue	0.14 0.04	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 5mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Hyper Red Blue	0.05 0.03	-	nm/°C
Temperature Coefficient of V_F I_F = 5mA, -10°C \leq T \leq 85°C	TC _V	Hyper Red Blue	-1.9 -2.9	-	mV/°C

Notes

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Dovementor	Symbol	Va	1114	
Parameter		Hyper Red	Blue	Unit
Power Dissipation	P _D	75	34	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 To +85		°C
Storage Temperature	T _{stg}	-40 To +85		°C
DC Forward Current	I _F	30	10	mA
Peak Forward Current	I _{FP} ^[1]	185	100	mA
Electrostatic Discharge Threshold (HBM)	-	3000	250	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	730	640	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	620	590	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{th \ JA}$, $R_{th \ JS}$ Results from mounting on PC board FR4 (pad size \geq 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

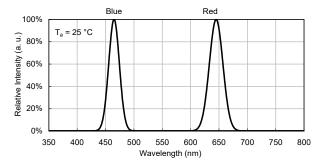


^{1.} The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

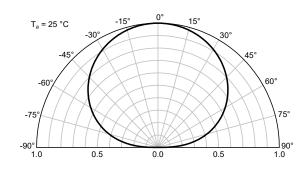


TECHNICAL DATA

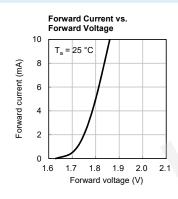
RELATIVE INTENSITY vs. WAVELENGTH

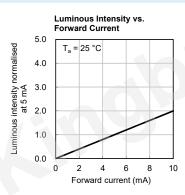


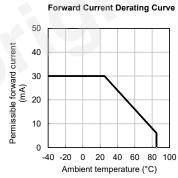
SPATIAL DISTRIBUTION

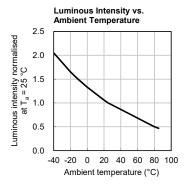


HYPER RED

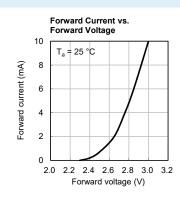


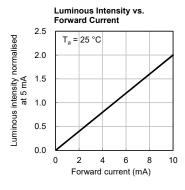


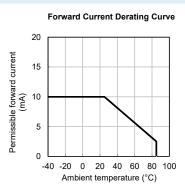


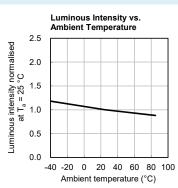


BLUE











REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~150s 60~120s 50 25°C 0 50 100 150 200 300 (sec) Time -

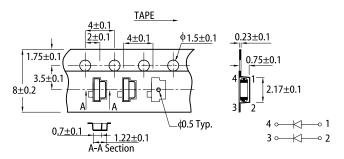
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

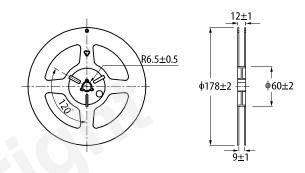
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might

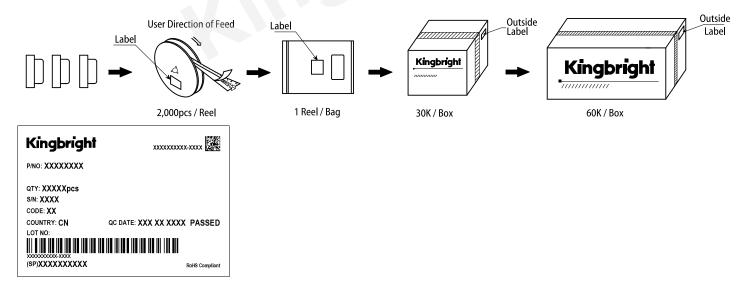
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should reference only. to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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